

9- and 11-Channel, Muxed Input LCD Reference Buffers

AD8509/AD8511

FEATURES

Single-supply operation: 3.3 V to 6.5 V

High output current: 300 mA
Low supply current: 6 mA
Stable with 1000 pF loads
Pin compatible with LMC6009
Pin compatible with CL-FP6131
48-lead, Pb-free TSSOP/LFCSP packages

APPLICATION

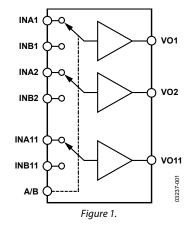
LCD line inversion gamma references

GENERAL DESCRIPTION

The AD8509 and AD8511 are 9-channel and 11-channel LCD reference buffers, respectively, designed to drive 64 gray scale column drivers. Each buffer has an A/B input to select between two voltages for LCD displays. These buffers drive the resistor ladders of LCD column drivers for gamma correction. The LCD drivers have higher slew rates and higher output drive currents than similar competitive parts. This increases the stability of the reference ladder, resulting in better gray scale and visual performance.

The AD8509 and AD8511 are specified over the -40° C to $+85^{\circ}$ C temperature range. They are available in 48-lead, Pb-free TSSOP packages in tape and reel. Additionally, the ADD8511 is available in a 48-lead, Pb-free LFCSP package.

FUNCTIONAL BLOCK DIAGRAM



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PIN CONFIGURATIONS

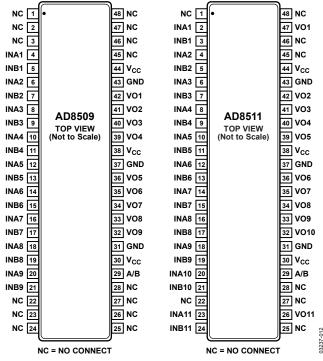
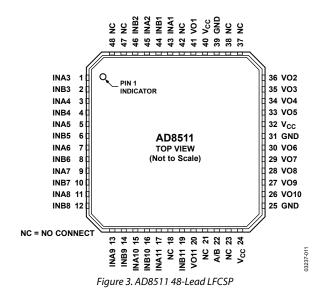


Figure 2. AD8509 and AD8511 48-Lead TSSOP (RV Suffix)



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REVISION HISTORY	
2/06—Rev. C	9/04—Rev. 0 to Rev. A
Added LFCSP PackageUniversal	Format UpdatedUniversa
Added Pin Configurations and Function Descriptions Section 5	Added Pb-Free PartUniversa
Updated Outline Dimensions	Changed Temperature RangeUniversa
Changes to Ordering Guide	Changed Applications Section
1/05—Rev. A to Rev. B	Changes to Ordering Guide
Changed Maximum Operating VoltageUniversal	10/05 D
Change to Features List	10/97—Revision 0: Initial Version

SPECIFICATIONS

ELECTRICAL CHARACTERISTICS

 V_S = 5 V, T_A = 25°C, unless otherwise noted.

Table 1.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
INPUT CHARACTERISTICS						
Offset Voltage	Vos				20	mV
Input Bias Current	I _B				50	nA
Voltage Gain	Avo		0.985			V/V
OUTPUT CHARACTERISTICS						
Output Voltage High	V _{OH}	$I_{LOAD} = +20 \text{ mA}$	4.8			V
Output Voltage Low	VoL	$I_{LOAD} = -20 \text{ mA}$			200	mV
Output Short-Circuit Current	I _{sc}		120	350		mA
POWER SUPPLY						
Load Regulation		$V_{IN} = 0.5 \text{ V to } 4.5 \text{ V, } I_{SOURCE} = 20 \text{ mA}$		7		mV
		$V_{IN} = 0.5 \text{ V to } 4.5 \text{ V, } I_{SINK} = 20 \text{ mA}$		7		mV
Supply Current	I _{SY}	$AD8509, V_{IN} = 2.5 V$			8.5	mA
	I _{SY}	AD8511, $V_{IN} = 2.5 \text{ V}$			10	mA
Supply Voltage Range	Vs		3.3		6.5	V
DYNAMIC PERFORMANCE						
Slew Rate		$C_L = 15 \text{ pF}$		7		V/µs
		$R_L = 250 \Omega$		6.2		V/µs
Settling Time	ts	IDC = 13 mA (sink/source)		3	6	μs
LOGIC INPUT CHARACTERISTICS						
Input Current Low	IIL				1.0	μΑ
Input Current High	I _{IH}				1.5	μΑ
Input Voltage Low	VIL				8.0	V
Input Voltage High	V _{IH}		2.0			V

ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter	Rating
Supply Voltage	7 V
Input Voltage	GND to Vs
Storage Temperature Range	
TSSOP (RV-48)	−65°C to +150°C
Operating Temperature Range	-40°C to +85°C
Junction Temperature Range	
TSSOP (RV-48) Package	−65°C to +150°C
Lead Temperature Range	
(Soldering, 60 sec)	300°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 3. Thermal Resistance

Package Type	θ _{JA}	θις	Unit
48-Lead, Pb-Free SSOP (RV-48)	115	42	°C/W
48-Lead, Pb-Free LFCSP (CP-48-1)	125	29	°C/W

Table 4. MUX Function

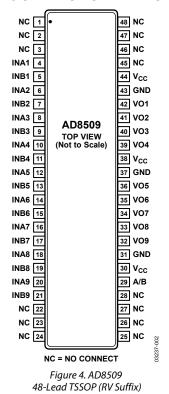
A/B Select	Input
Logic High	INAx
Logic Low	INBx

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS



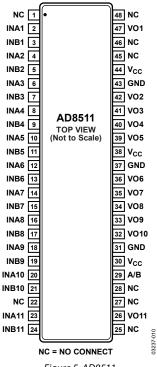
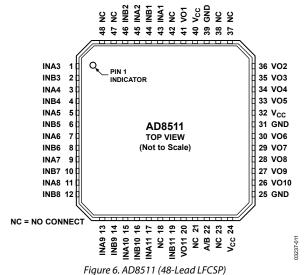


Figure 5. AD8511 48-Lead TSSOP (RV Suffix)



rigure 6. AD6511 (46-Leda)

AD8509 (TSSOP)	AD8511 (TSSOP)	AD8511 (LFCSP)	Mnemonic	Description
4, 6, 8, 10, 12, 14, 16, 18, 20	2, 4, 6, 8, 10, 12, 14, 16, 18, 20, 23	1, 3, 5, 7, 9, 11, 13, 15, 17, 43, 45	INAx	MUX Input
5, 7, 9, 11, 13, 15, 17, 19, 21	3, 5, 7, 9, 11, 13, 15, 17, 19, 21, 24	2, 4, 6, 8, 10, 12, 14, 16, 19, 44, 46	INBx	MUX Input
32 to 36, 39 to 42	26, 32 to 36, 39 to 42, 47	20, 26 to 30, 33 to 36, 41	VOx	MUX Output
29	29	22	A/B	Input Selection Pin
30, 38, 44	30, 38, 44	24, 32, 40	Vcc	Bias
31, 37, 43	31, 37, 43	25, 31, 39	GND	Ground
1 to 3, 22 to 28, 45 to 48	1, 22, 25 27, 28, 45, 46, 48	18, 21, 23, 37, 38, 42, 47, 48	NC	No Connection

Table 5. Pin Function Descriptions

TYPICAL PERFORMANCE CHARACTERISTICS

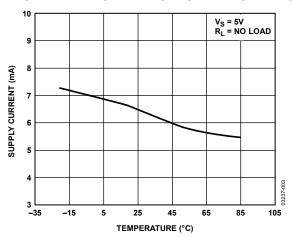


Figure 7. Supply Current vs. Temperature

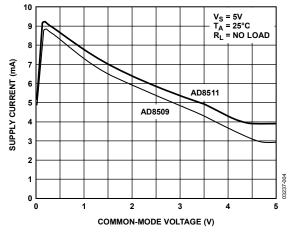


Figure 8. Supply Current vs. Common-Mode Voltage

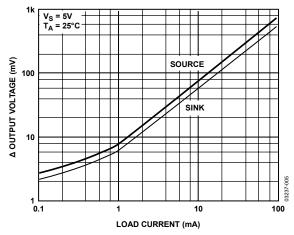


Figure 9. Output Voltage to Supply Rail vs. Load Current

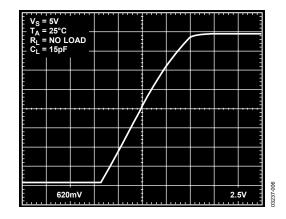


Figure 10. Large Signal Transient Response—Rising

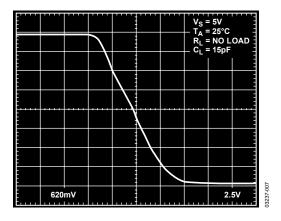


Figure 11. Large Signal Transient Response—Falling

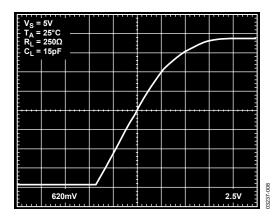


Figure 12. Large Signal Transient Response—Rising

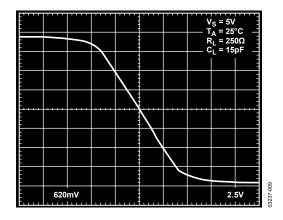


Figure 13. Large Signal Transient Response—Falling

APPLICATIONS

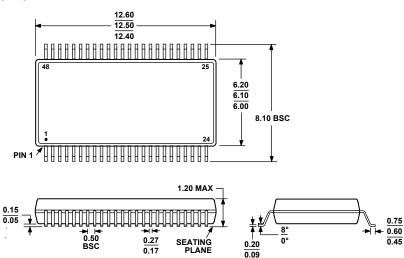
The AD8509 and AD8511 are CMOS buffers with A/B inputs that are used to select between two different reference voltages set up by an external resistor ladder. Input bias currents are orders of magnitude less than competitive parts. This allows very large resistor ladders to be used to save supply current. A guaranteed value of 50 nA is much higher than actual values and is limited by leakage in the test system.

Buffer outputs are designed to drive resistive loads. They are also stable with capacitive loads, so no resistors should be used in series with these outputs to attain the best display performance. Outputs have high slew rates and 6 μs settling times. Each output can deliver a minimum of 120 mA, assuring fast response to varying loads.

The AD8509 is a 9-channel buffer and is similar to the LMC6009 in functionality. The AD8511 is an 11-channel buffer similar to the CL-FP6131. However, the control to select either 9- or 11-channel operation, the EN_11 pin of the CL-FP6131, is not available on the AD8511. If 9-channel operation is desired, use the AD8509.

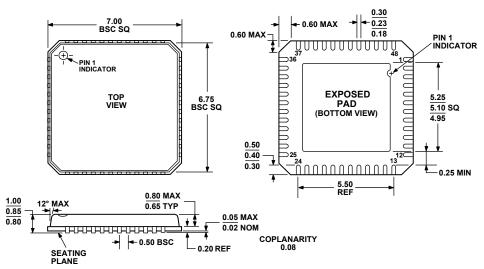
Power supply pins on the AD8509 and AD8511 have multiple ground and $V_{\rm CC}$ connections. Because of the high peak currents that these buffers can deliver, it is strongly recommended to connect all of the ground and $V_{\rm CC}$ pins, and suitably bypass the $V_{\rm CC}$ pins.

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-153-ED

Figure 14. 48-Lead Thin Shrink Small Outline Package [TSSOP] (RV-48) Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-220-VKKD-2

Figure 15. 48-Lead Lead Frame Chip Scale Package [LFCSP_VQ] 7 mm x 7 mm Body, Very Thin Quad (CP-48-1) Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature Range	Package Description	Package Option
AD8509ARU-REEL	-40°C to +85°C	48-Lead Thin Shrink Small Outline Package [TSSOP]	RV-48
AD8509ARUZ-REEL ²	-40°C to +85°C	48-Lead Thin Shrink Small Outline Package [TSSOP]	RV-48
AD8511ARU-REEL	-40°C to +85°C	48-Lead Thin Shrink Small Outline Package [TSSOP]	RV-48
AD8511ARUZ-REEL ²	-40°C to +85°C	48-Lead Thin Shrink Small Outline Package [TSSOP]	RV-48
AD8511ACPZ-REEL ²	-40°C to +85°C	48-Lead Lead Frame Chip Scale Package [LFCSP_VQ]	CP-48-1

¹ All models only available in 2,500-piece reels.

 $^{^{2}}$ Z = Pb-free part.

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